

ZXLD1374EV2 BUCK/BOOST LED DRIVER USER GUIDE

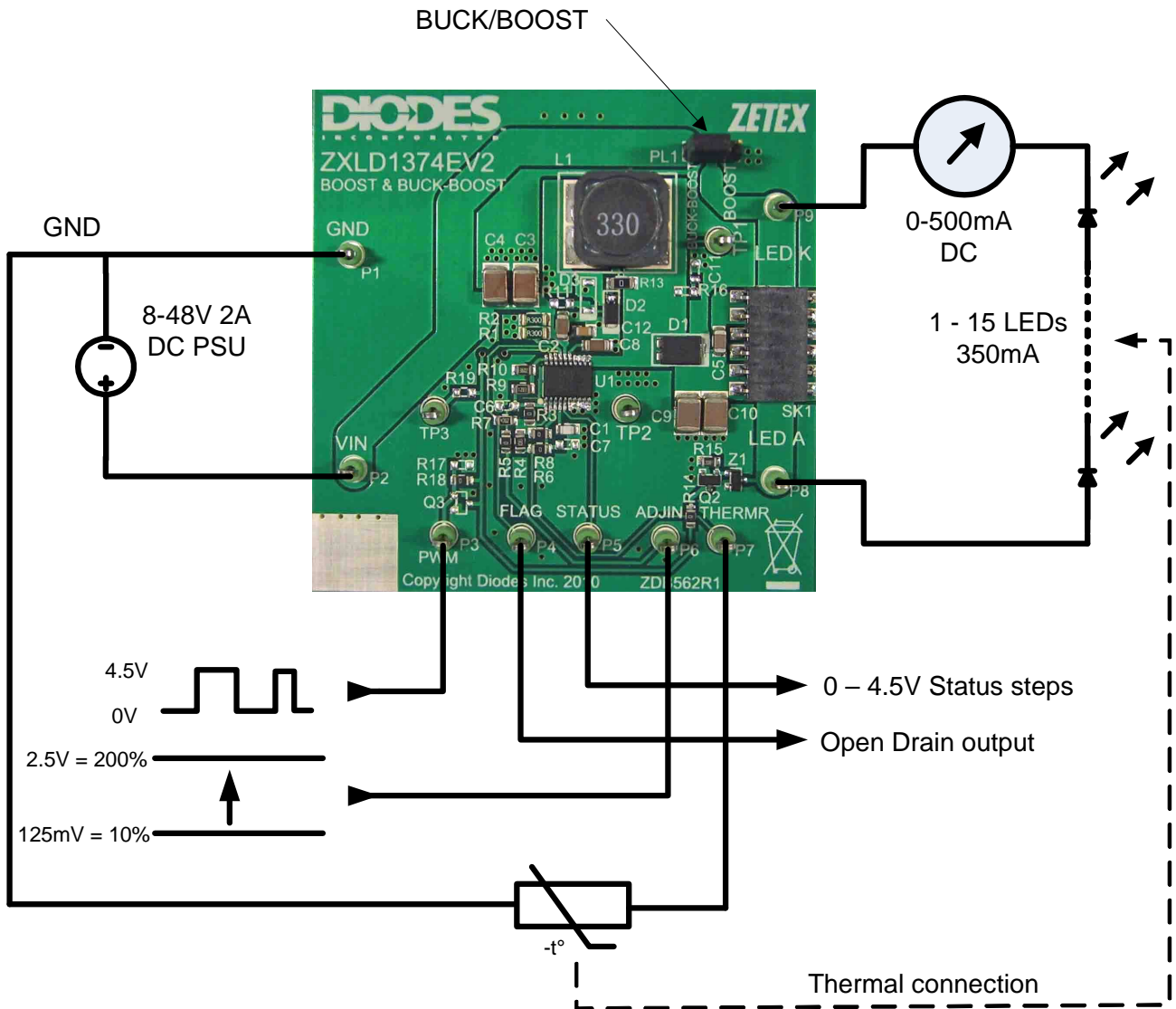


Fig.1 ZXLD1374EV2 Evaluation board connection diagram

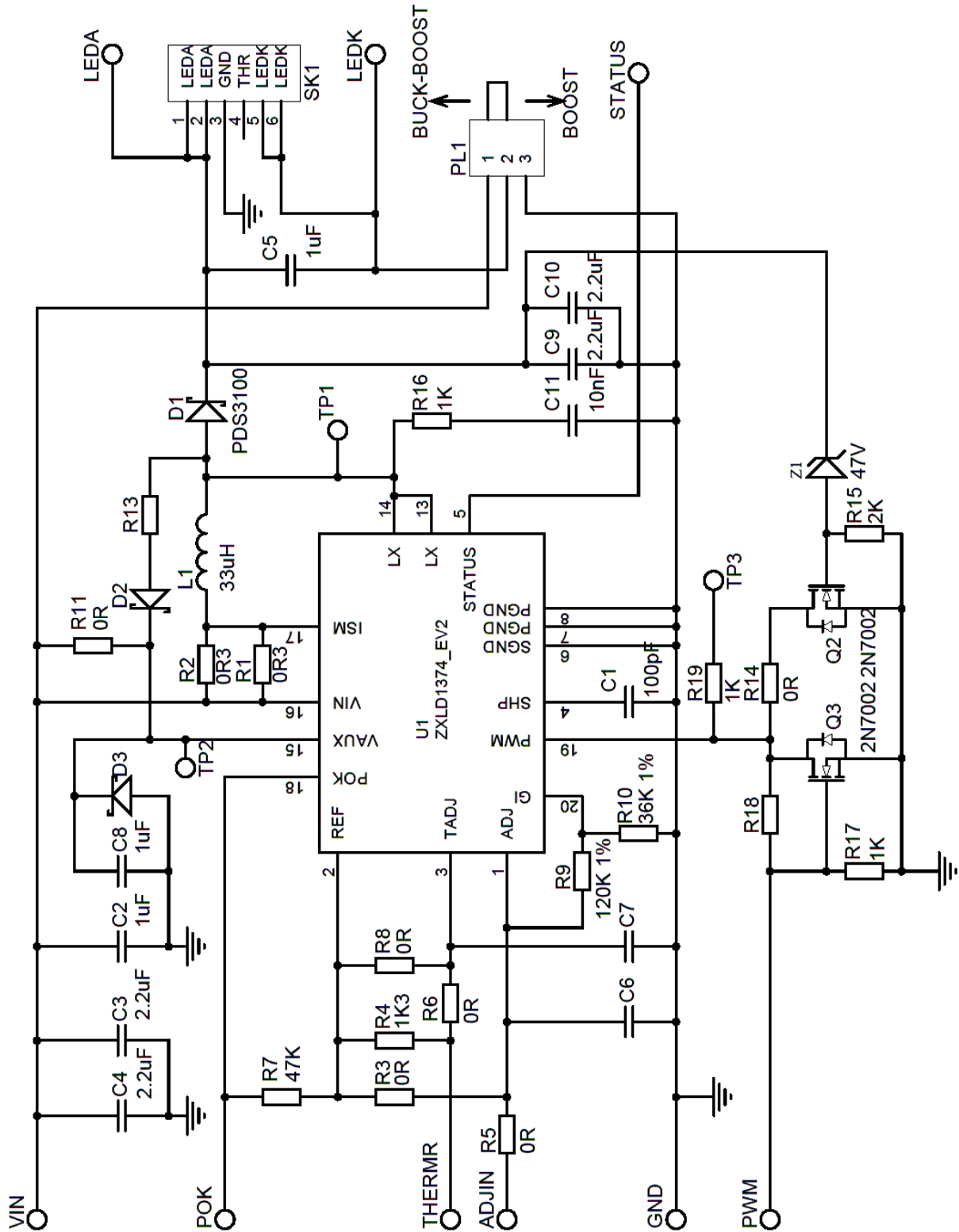


Fig2. Schematic diagram

PARTS LIST

Ref	Value	Package	Part Number	Manufacturer	Contact Details
U1	1.5A LED Driver	TSSOP20L- EP	ZXLD1374EST20TC	Diodes	www.diodes.com
Q2	60V General Purpose MOSFET	SOT23	2N7002	Diodes	www.diodes.com
Q3	NOT FITTED				
D1	Freewheeling diode 3A 100V	PowerDI5	PDS3100	Diodes	www.diodes.com
D2	1A 60V diode	PowerDI123	DFLS160	Diodes	
D3	NOT FITTED				www.diodes.com
Z1	62V 250mW Zener Diode	SOT23	BZX84C62	Diodes	www.diodes.com
L1	33uH 2.1A		MSS1038-333MLB NPIS104F330MTRF 744-066-330	Coilcraft NIC Comps. Würth	www.coilcraft.com www.niccomp.com www.we-online.com
C1	100pF 50V COG	0805		Generic	
C2 C5 C8	1uF 100V X7R	1206	GRM31CR72A105K A01L	Murata	www.murata.com
C3 C4 C9 C10	2.2uF 100V X7R	1812	GRM43ER72A225K A01L	Murata	www.murata.com
C6 C7 C11	NOT FITTED				
C12	100nF 100v X7R	0805			
R1 R2	0R3	1206		Generic	
R4	1K3	0805		Generic	
R7	47K	0805		Generic	
R9	120K 1%	0805		Generic	
R10	36K 1%	0805		Generic	
R3 R5 R6 R8 R14 R18	0R0	0805		Generic	
R13	0R0	1206		Generic	
R15	2K	0805		Generic	
R11 R16 R17 R19	NOT FITTED				

NOTES

The PCB is supplied with R3 and R8 0R0 resistors fitted.
 The 'ADJ' pin and the 'TADJ' pins are disabled.
 Boost-only mode is selected by changing PL1 selector.

In Boost mode, the total LED output voltage is $\leq 60V$.
 The supply voltage for the ZXLD1374EV2 is $\geq 6V$, \leq (total LED voltage).

In Buck-boost operation, the input voltage range is limited by the max LX voltage and the LED voltage.
 $\geq 6V$, $\leq (60V - V_{LED})$.

For other reference designs or further applications information, please refer to the ZXLD1374 datasheet.

Q2 and Z1 protect the circuit from open-circuit LEDs.

The overvoltage threshold of the evaluation board is 62V. (Set by the 62V Zener diode Z1)

Do not use a Zener diode of higher voltage than 62V since absolute max rating for the ZXLD1374 is 65V.

For Boost and Buck-boost modes the average LED current is:

$$I_{LED} = \text{average } I_{INDUCTOR} \times R10 / (R9 + R10)$$

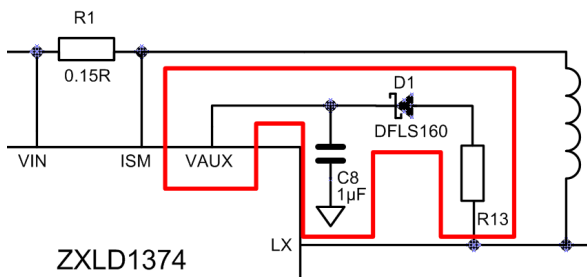
The nominal current, I_{LED} for the evaluation board is set to 350mA.

OPERATION

In Boost and Buck-boost mode the LED current is sensed by the series resistor (R1 // R2). An output from the control loop drives the input of an internal comparator. The comparator drives the gate of the internal NMOS switch transistor. When the NMOS switch is on (LX pin low), current flows from VIN, via (R1 // R2), inductor and switch to ground and increases until a high value is reached. Then, the switch turns off (LX pin high) and the current flows through (R1 // R2), the inductor, D1 and the LED, to 'VIN' (Buck-boost mode), or 'GND' (Boost mode). When the inductor current has gone low, 'LX' goes low, and the cycle of events repeats resulting in the circuit oscillates. The average current in the LEDs is equal to the average of the maximum and minimum threshold currents. The ripple current (hysteresis) is equal to the difference between the thresholds. The average current in the LED is always less than the average current in the inductor and the ratio between these currents is set by the values of resistors R9 and R10. The peak current in the LED is equal to the peak current in the inductor. The control loop keeps the average LED current at the level set by the voltage on the 'ADJ' pin. Loop compensation is achieved by C1.

Bootstrap Circuit

For input voltages between 6-12V and high switch currents that require a fully enhanced MOSFET, it is required to use the bootstrap network D2-R13 and remove R11.



For input voltages higher than 12V and high switch currents, the MOSFET is fully enhanced. The bootstrap network D2-R13 is not required and can be removed. The resistor R11 (0R0) need to be fitted to supply VAUX.

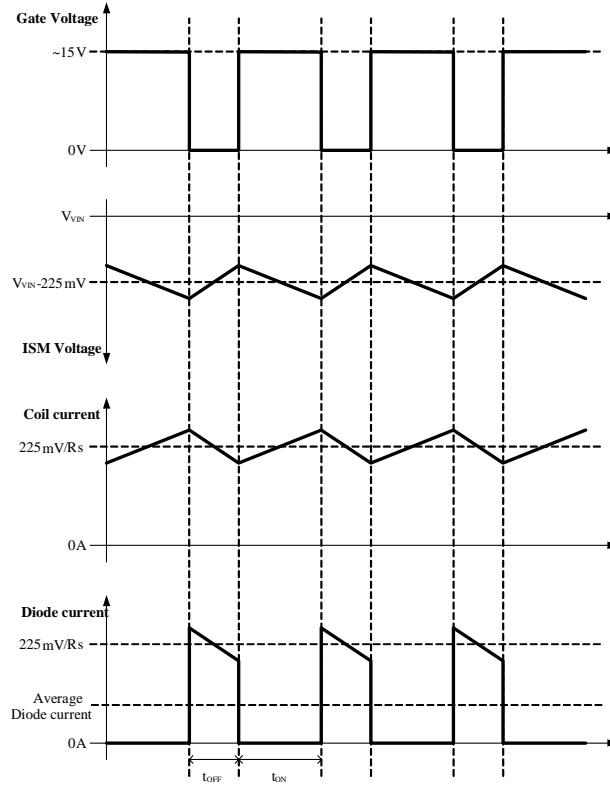


Fig. 3 Waveforms for Boost and Buck-boost modes

ADJ Terminal (DC output current adjustment)

On the ZXLD1374EV2, the 'ADJ' pin R3 connects the internal 1.25V reference (V_{REF}) give 100% LED current.

The ADJ pin can also be driven with an external DC voltage $\geq 125\text{mV}$ and $\leq 2.5\text{V}$ to adjust the LED current to $\geq 10\%$ and $\leq 200\%$ of the nominal value.

To do this, remove R3, fit R5 and apply an external DC voltage between the connectors 'ADJIN' and 'GND'

The voltage V_{ADJ} can be derived from a resistor-divider connected between 'REF' and 'GND'.

'ADJ' has high impedance within its normal operating voltage range. An internal 2.6V clamp protects the device against excessive input voltage and limits the maximum output current to approximately 4% above the maximum current set by ' V_{ADJ} ' if the maximum input voltage is exceeded.

PWM Terminal (PWM output current control/dimming)

The LED current can be adjusted digitally, by applying a low frequency PWM logic signal to the 'PWM' pin to turn the controller on and off. This will produce an average output current proportional to the duty cycle of the control signal. During PWM operation, the device remains powered up and only the output switch is switched by the control signal.

The device can be shut down by taking the PWM pin to $< 0.4\text{V}$ for $> 15\text{ms}$ (with a short to 0V or suitable open collector NPN, or open drain NMOS transistor). In the shutdown state, most of the circuitry inside the device is off and the quiescent current will be typically $90\mu\text{A}$.

TADJ Terminal (Thermal control of LED current)

The 'Thermal control' circuit monitors the voltage on the 'TADJ' pin and reduces the output current linearly if the voltage on 'TADJ' $< 625\text{mV}$. An NTC thermistor and resistor can be connected to set the voltage on the 'TADJ' pin = 625mV at the required threshold temperature. This will give 100% LED current below the threshold temperature and $< 100\%$ above it as shown in the graph. The temperature threshold can be changed by adjusting the value of R_{th} and/or the thermistor to suit the LED used.

On the ZXLD1374EV2, R_{th} is 1K3 (R4). In order to use thermal control, remove R8, fit R6, and fit a 10K NTC Negative Temperature Coefficient) type thermistor between 'TADJ' and 'GND'. This will set the threshold temperature to $\sim 90^\circ\text{C}$.

Thermal control by LED current reduction

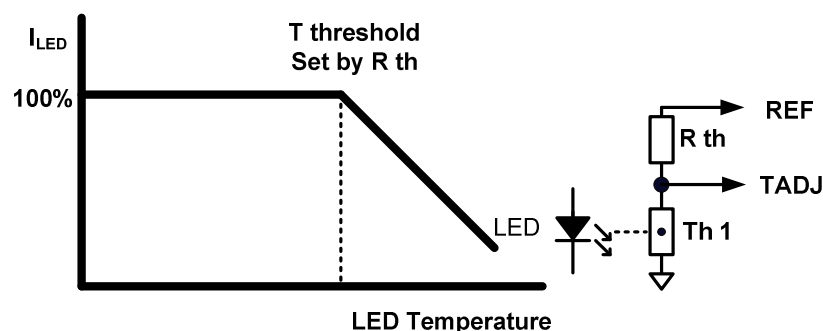
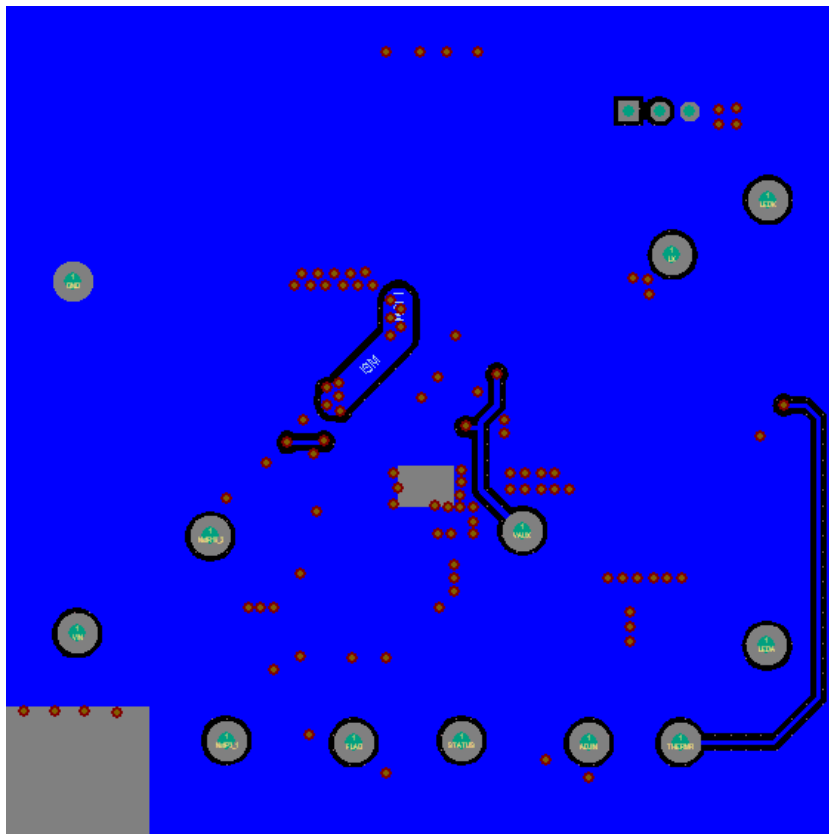
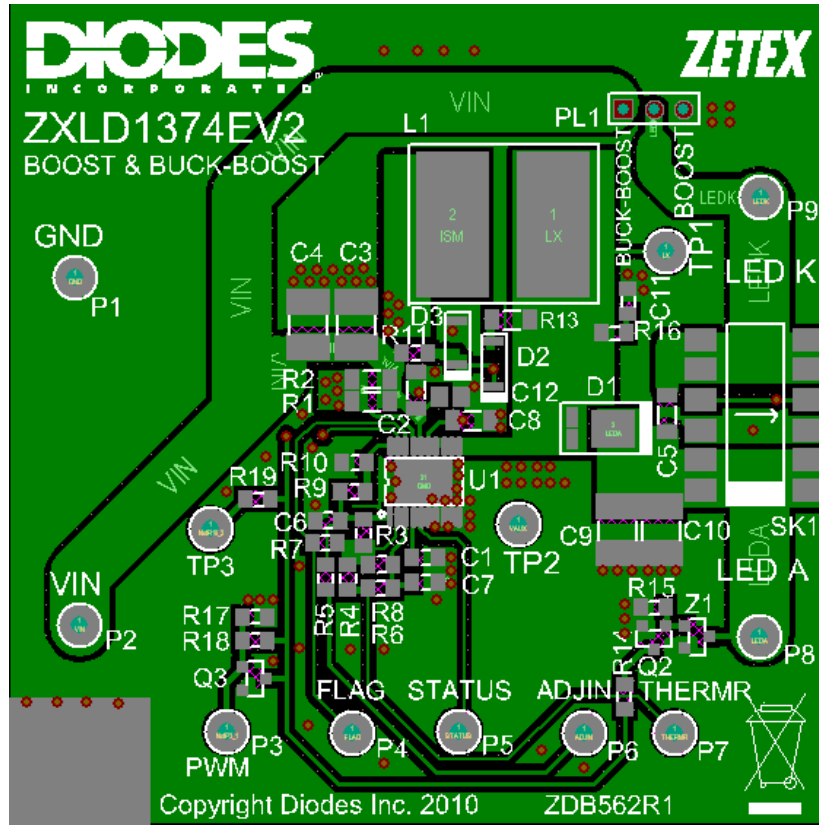


Fig. 4 Thermal control

The Thermal Control feature can be disabled by connecting TADJ to REF through the jumper resistor R8.

BOARD LAYOUT



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